IAP20 Rec'd PCT/PTO 14 JUN 2006

APPLICATION DATA SHEET

Secrecy Order in Parent Appl.?::

Application Information	
Application number::	
Filing Date::	
Application Type::	Regular
Subject Matter::	Utility
Suggested classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R?::	None
Number of CD disks::	
Number of copies of CDs::	
Sequence submission?::	
Computer Readable Form (CRF)?::	No
Number of copies of CRF::	
Title ::	DIELECTRIC PASTE FOR SPACER LAYER OF
	A MULTI-LAYERED CERAMIC ELECTRONIC
	COMPONENT
Attorney Docket Number::	890050.541USPC
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	
Total Drawing Sheets::	
Small Entity?::	No
Petition included?::	No
Petition Type::	
Licensed U.S. Gov't Agency::	
Contract or Grant No::	

No

1

First Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Status::

Full Capacity

Given Name::

Shigeki

Middle Name::

Family Name::

Satou

Name Suffix::

City of Residence::

Tokyo

State or Province of Residence::

Country of Residence::

Japan

Street of mailing address::

c/o TDK Corporation, 1-13-1,

Nihonbashi, Chuo-ku

City of mailing address::

Tokyo

State or Province of mailing address::

Country of mailing address::

Japan

Postal or Zip Code of mailing address::

103-8272

2 Initial 06/14/06

Second Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Status::

Full Capacity

Given Name::

Takeshi

Middle Name::

Family Name::

Nomura

Name Suffix::

City of Residence::

Tokyo

State or Province of Residence::

Country of Residence::

Japan

Street of mailing address::

c/o TDK Corporation, 1-13-1,

Nihonbashi, Chuo-ku

City of mailing address::

Tokyo

State or Province of mailing address::

Country of mailing address::

Japan

Postal or Zip Code of mailing address::

103-8272

Correspondence Information

Correspondence Customer Number ::

00500

Representative Information

Representative Customer Number:: 00	500
-------------------------------------	-----

3 Initial 06/14/06

Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2004/018627	12/14/04

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2003-416157	12/15/03	Yes

Assignee Information

Assignee name::	TDK Corporation
Street of mailing address::	1-13-1, Nihonbashi, Chuo-ku
City of mailing address::	Tokyo
State or Province of mailing address::	
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	103-8272

794817_1.DOC

4 Initial 06/14/06